

Powering the AM64x with the TPS65220 or TPS65219 PMIC



ABSTRACT

This application note can be used as a guide for integrating the TPS65220 or TPS65219 Power Management IC (PMIC) into non-automotive systems powering the Industrial AM64x Sitara Processor. An orderable part number comparison table details the configurations of several factory programmed TPS65220 and TPS65219 variants that can support different AM64x use cases. Example power maps are provided to assist the design process.

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1 Introduction

The TPS65220 PMIC is a cost and space optimized solution specially designed to power the AM64x processor and its principal peripherals. A hardware solution is readily available with the AM64x SK EVM Revision 2 using TPS65220 PMIC (SK-AM64B). In addition, functional spin TPS65219 PMIC has flexible mapping and comes in several factory programmed variants to support different AM64x use cases. The AM64x is within the Sitara™ family of Arm® processors, and provides highly flexible, real-time, and low latency processing for a broad range of industrial applications. To be used in applications from motor drives to Programmable Logic Controllers (PLCs), this processor provides powerful computing while supporting power management features designed for portable or power-sensitive systems. Powering a processor such as the AM64x family demands requirements such as sufficient current headroom, tight transient requirements, and a number of rails that can be fully controlled for power up and power down sequencing.

The AM64x processor requires at minimum, power for seven main rails. These include the core supply rails (VDD_CORE and VDDR_CORE), DDR IO supply (VDDS_DDR), and 1.8 V and 3.3 V digital and analog IO rails (VDDSHVx, VDDSHV_MCU, VDDSHVy, VDDA_MCU). This application note discusses the TPS65220 and TPS65219 power management IC (PMIC) and their full feature-set, specially designed to power the AM64 Sitara™ processor and its principal peripherals.

2 TPS65220 and TPS65219 Overview

The TPS65220 and TPS65219 PMICs each contain seven regulators, 3 Buck regulators and 4 Low Drop-out Regulators (LDOs). The Buck converters are capable of supporting up to 3.5 A for Buck1, and 2 A each for the remaining buck regulators. LDO1 and LDO2 (2×400 mA) are configurable for load switch and bypass mode to support dynamic SD card voltages, while LDO3 and LDO4 (2×300 mA) are configurable as load switches. With a VIN range of 2.5 V to 5.5 V, the PMIC can support a common 3.3 V or 5 V system voltage. With an I2C interface, three GPIO pins, and three multi-function-pins, the TPS65220 and TPS65219 PMIC each provides the full power package to supply the AM64x SoC, as well as many other SoCs. [Table 2-1](#) provides a summary of the TPS65220 and TPS65219 Power Resources.

TPS65220 is characterized for -40°C to +125°C ambient temperature, and TPS65219 is characterized for -40°C to +105°C ambient temperature. The extended PMIC temperature range of TPS65220 allows support of AM64x based systems operating at higher temperatures. For safety sensitive applications, TPS65220 is functional safety capable. Therefore the TPS65220 development process is a TI-quality managed process, also functional safety FIT rate calculation and Failure mode distribution (FMD) is available for TPS65220. The TPS65220 device also provides flexibility in switching frequency, since it can support depending on programmed NVM settings either 2.3 MHz fixed frequency or 2.3MHz quasi-fixed frequency allowing low IQ/auto-PFM and Forced PWM modes. [Table 2-2](#) provides a features comparison between the TPS65220 and TPS65219.

Table 2-1. TPS65220 and TPS65219 Power Resources

	Input Voltage	Output Voltage	Current Capability	Comments
BUCK1	2.5 V - 5.5 V	0.6 V - 3.4 V	3.5 A	<ul style="list-style-type: none"> 2.3 MHz quasi-fixed frequency. TPS65220 can also support fixed frequency depending on configuration Low IQ/auto-PFM and Forced PWM modes supported. Programmable power sequencing and default voltages Integrated voltage supervisor for undervoltage Supports dynamic voltage scaling (not needed when powering AM64x)
BUCK2	2.5 V - 5.5 V	0.6 V - 3.4 V	2 A	
BUCK3	2.5 V - 5.5 V	0.6 V - 3.4 V	2 A	
LDO1	1.5 V - 5.5 V	0.6 V - 3.4 V	400 mA	<ul style="list-style-type: none"> Configurable as load switch and bypass-mode supporting SD-Card Integrated voltage supervisor for undervoltage
LDO2	1.5 V - 5.5 V	0.6 V - 3.4 V	400 mA	
LDO3	2.5 V - 5.5 V	1.2 V - 3.3 V	300 mA	<ul style="list-style-type: none"> Configurable as load switch Integrated voltage supervisor for undervoltage
LDO4	2.5 V - 5.5 V	1.2 V - 3.3 V	300 mA	

Table 2-2. TPS65220 and TPS65219 Features Comparison

Feature	TPS65220	TPS65219
Switching Frequency	Up to 2.3MHz . Capable of either quasi-fixed frequency or fixed-frequency depending on device configuration (programmed NVM settings). Quasi-fixed frequency: <ul style="list-style-type: none"> • Auto-PFM • Forced-PWM Fixed-frequency: <ul style="list-style-type: none"> • Spread spectrum available 	Up to 2.3 MHz Quasi-fixed frequency: <ul style="list-style-type: none"> • Auto-PFM • Forced-PWM
Operating Free-Air Temp T_A	-40C to 125C	-40C to 105C
Operating Junction Temp T_J	-40C to 150C	-40C to 125C
Functional Safety Capable	Functional Safety Capable (TI Quality managed process, Functional safety FIT rate calculation, and Failure Mode Distribution is available)	No
EVM availability	SK-AM64B EVM boards available on Ti.com starting September 2022.	TPS65219EVM (PMIC only. Does not include processor)
Package	One package option: <ul style="list-style-type: none"> • 5 mm × 5 mm, 0.5 mm pitch VQFN 	Two package options: <ul style="list-style-type: none"> • 4 mm × 4 mm, 0.4 mm pitch VQFN • 5 mm × 5 mm, 0.5 mm pitch VQFN

2.1 TPS65220 and TPS65219 Functional Block Diagram

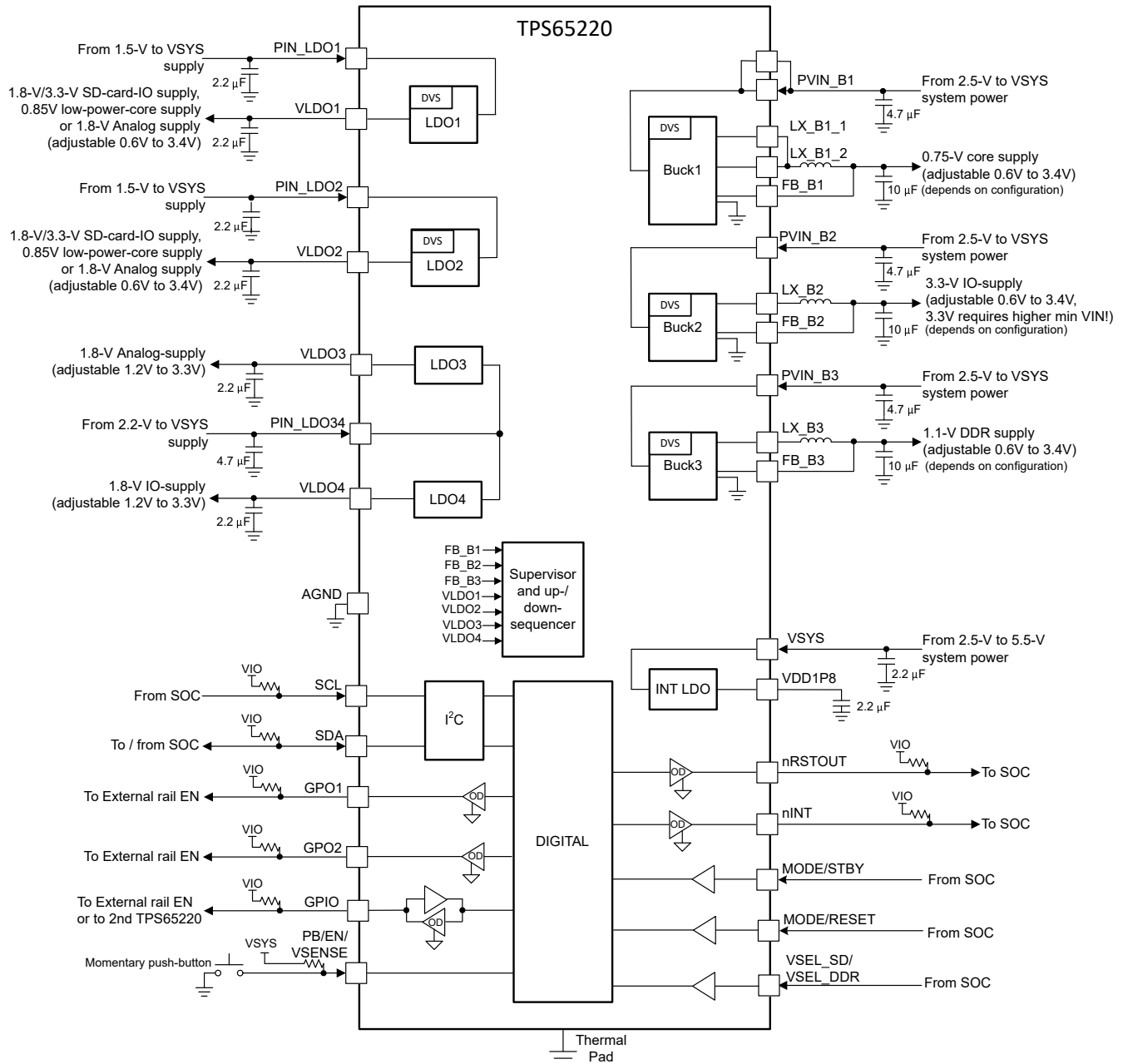


Figure 2-1. TPS65220 Functional Block Diagram

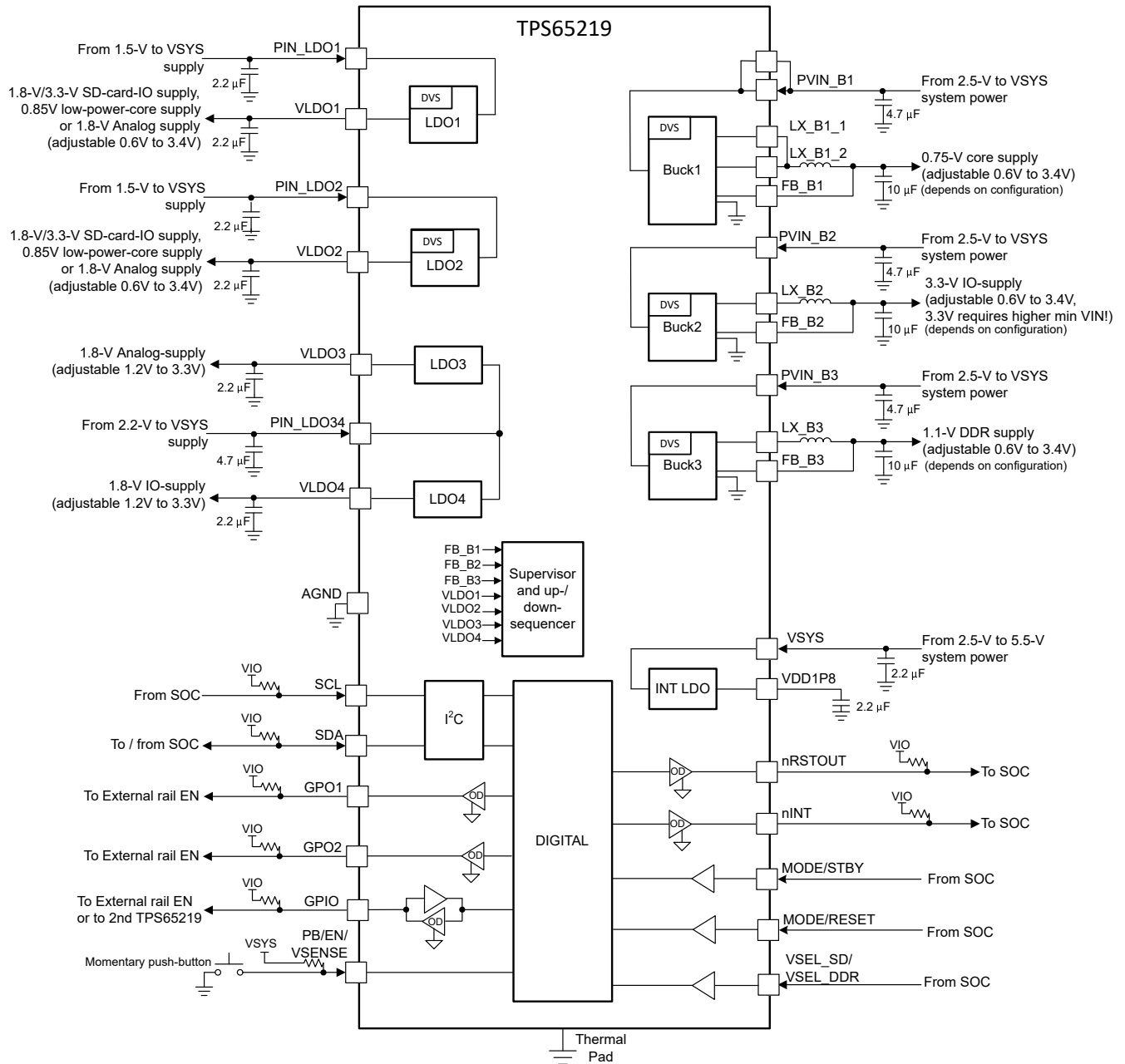


Figure 2-2. TPS65219 Functional Block Diagram

3 TPS65220 and TPS65219 Variants

There are five different orderable part number (OPN) variants of the TPS65220 and TPS65219 PMIC that come factory programmed to power the AM64x processor. Selecting the right OPN will be based on the application use case and design requirements. [Table 3-1](#) compares the NVM configurations from the output voltages on each rail to the configuration of the digital pins as well as the package options. This table also includes the reference hardware that is available to support new designs. For additional detailed information, please refer to the device data sheet and technical reference manual (TRM) available at TI.com.

Table 3-1. TPS65220 and TPS65219 Variant Comparison Table

		TPS6522053 Section 4	TPS6521901 Section 4.1	TPS6521902 Section 4.2	TPS6521903 Section 4.3	TPS6521904 Section 4.4
Use Case	Vsys	3.3V	5 V	3.3 V	3.3 V	3.3 V
	External Memory Support	LPDDR4	DDR4	LPDDR4	DDR4	DDR4
BUCK1	Vout	0.75V	0.75 V	0.75 V	0.75 V	0.85 V
	Bandwidth	High Bandwidth	High bandwidth	High bandwidth	High bandwidth	High bandwidth
BUCK2	Vout	1.8 V	3.3 V	1.8 V	1.8 V	1.8 V
	Bandwidth	High Bandwidth	High bandwidth	High bandwidth	High bandwidth	High bandwidth
BUCK3	Vout	1.1 V	1.2 V	1.1 V	1.2 V	1.2 V
	Bandwidth	High Bandwidth	High bandwidth	High bandwidth	High bandwidth	High bandwidth
LDO1	Vout	3.3 V (Bypass)	3.3 V (Bypass)	3.3 V (Bypass)	3.3 V (Bypass)	3.3 V (Bypass)
LDO2	Vout	0.85 V	0.85 V	0.85 V	0.85 V	1.8 V (Bypass)
LDO3	Vout	1.8 V	1.8 V	1.8 V	1.8 V	1.8 V
LDO4	Vout	2.5 V	2.5 V	2.5 V	2.5 V	2.5 V
GPIO	GPO1	Disabled	Enabled	Disabled	Disabled	Disabled
	GPO2	Enabled	Disabled	Enabled	Enabled	Enabled
	GPIO	Disabled	Disabled	Disabled	Disabled	Disabled
	Multi-Device	Disabled	Disabled	Disabled	Disabled	Disabled
MODE_RESET	Config	Warm reset	Warm reset	Warm reset	Warm reset	Warm reset
MODE_STANDBY	Config	Mode and Standby	Mode and Standby	Mode and Standby	Mode and Standby	Mode and Standby
VSEL_SD_DDR	Config	SD	SD	SD	SD	SD
	Polarity	High = VOUT Low = 1.8 V	High = VOUT Low = 1.8 V	High = VOUT Low = 1.8 V	High = VOUT Low = 1.8 V	High = VOUT Low = 1.8 V
	Rail	LDO1	LDO1	LDO1	LDO1	LDO1
EN_PB_VSENSE	Config	Enable	Enable	Push-button	Push-button	Push-button
First Supply detection [1]	FSD config	Enabled	Enabled	Enabled	Enabled	Enabled
Additional Features	Temperature Range	T _A : -40°C to 125°C T _J : -40°C to 150°C	T _A : -40°C to 105°C T _J : -40°C to 125°C	T _A : -40°C to 105°C T _J : -40°C to 125°C	T _A : -40°C to 105°C T _J : -40°C to 125°C	T _A : -40°C to 105°C T _J : -40°C to 125°C
	Functional Safety Capable	Yes	No	No	No	No
Orderable Part Number	Package size 5 x 5 mm	TPS6522053RHBR	TPS6521901RHBR	TPS6521902RHBR	TPS6521903RHBR	TPS6521904RHBR
	Package size 4 x 4 mm	N/A	TPS6521901RSMR	TPS6521902RSMR	TPS6521903RSMR	TPS6521904RSMR
Design Resources	Reference Hardware	SK-AM64B EVM	TPS65219EVM (PMIC only. Does not include processor)	N/A	N/A	N/A
	Reference Hardware Availability	Boards available on Ti.com starting September 2022.	Boards and design files available now on Ti.com.	N/A	N/A	N/A

[1] First Supply detection allows power-up as soon as supply voltage is applied, even if EN/PB/VSENSE pin is at OFF_REQ status. FSD can be used in combination with any ON-request configuration, EN, PB or VSENSE. At first power-up the EN/PB/VSENSE pin is treated as if it had a valid ON request.

4 TPS6522053 Powering AM64x

Use case: VSYS=3.3V, LPDDR4 Memory, Extended Temperature Range, Functional Safety Capable

Figure 4-1 shows the TPS6522053 variant powering the AM64x processor on a system with 3.3 V input supply and LPDDR4 memory. The 3.3 V coming from the pre-regulator is connected to the main input supply for reference system (VSYS) and to the power input of the buck converters (PVIN_Bx) and LDO1, LDO3, and LDO4 (PVIN_LDO1, PVIN_LDO34). The 3.3 V coming from the pre-regulator can be combined with a power switch to supply the 3.3 V VDDSHVx IO domain. Buck1 is used to supply VDD_CORE at 0.75 V. Buck3 and Buck2 supports the 1.1 V and 1.8 V required by VDDS_DDR and the DVDD1V8 domain. They are also used to support the required voltages on the LPDDR4 memory. The GPO2 is pre-programmed to be enabled in the second slot of the power-up sequence with a duration of 6ms. It can be used to enable the external power switch and meet the processor sequence requirements. The switch must be selected with the right electrical spec to ramp and provide a stable output voltage within the 6ms duration of the second slot (before the PMIC starts the next slot in the power-up sequence). LDO1, configured as bypass, allows dynamic SD card voltage changes between 3.3 V and 1.8 V. This voltage change on LDO1 can be triggered by I2C or by setting the VSEL_SD pin high (LDO1=3.3 V) or low (LDO1=1.8 V). LDO2, is used to supply the VDDR_CORE. LDO3 supports the 1.8 V analog domain. LDO4 is a free 2.5 V power resource that can be used for external peripherals like the Ethernet PHY. GPIO and GPO1 are free digital resources that are disabled by default but could be enabled through I2C if needed. Figure 4-2 and Figure 4-3 shows the power-up and power-down sequence programmed on TPS6522053.

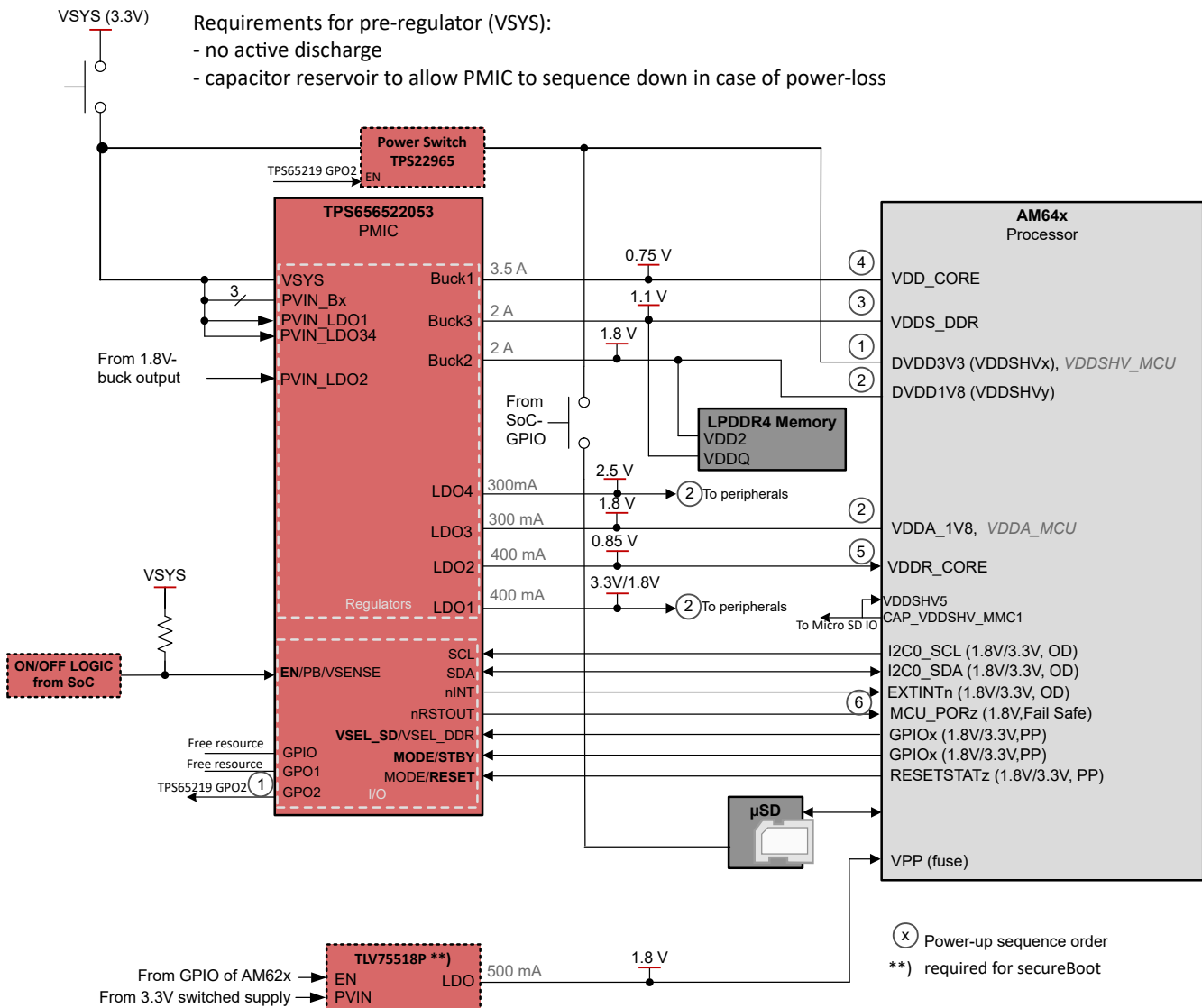


Figure 4-1. TPS6522053 Powering AM64x

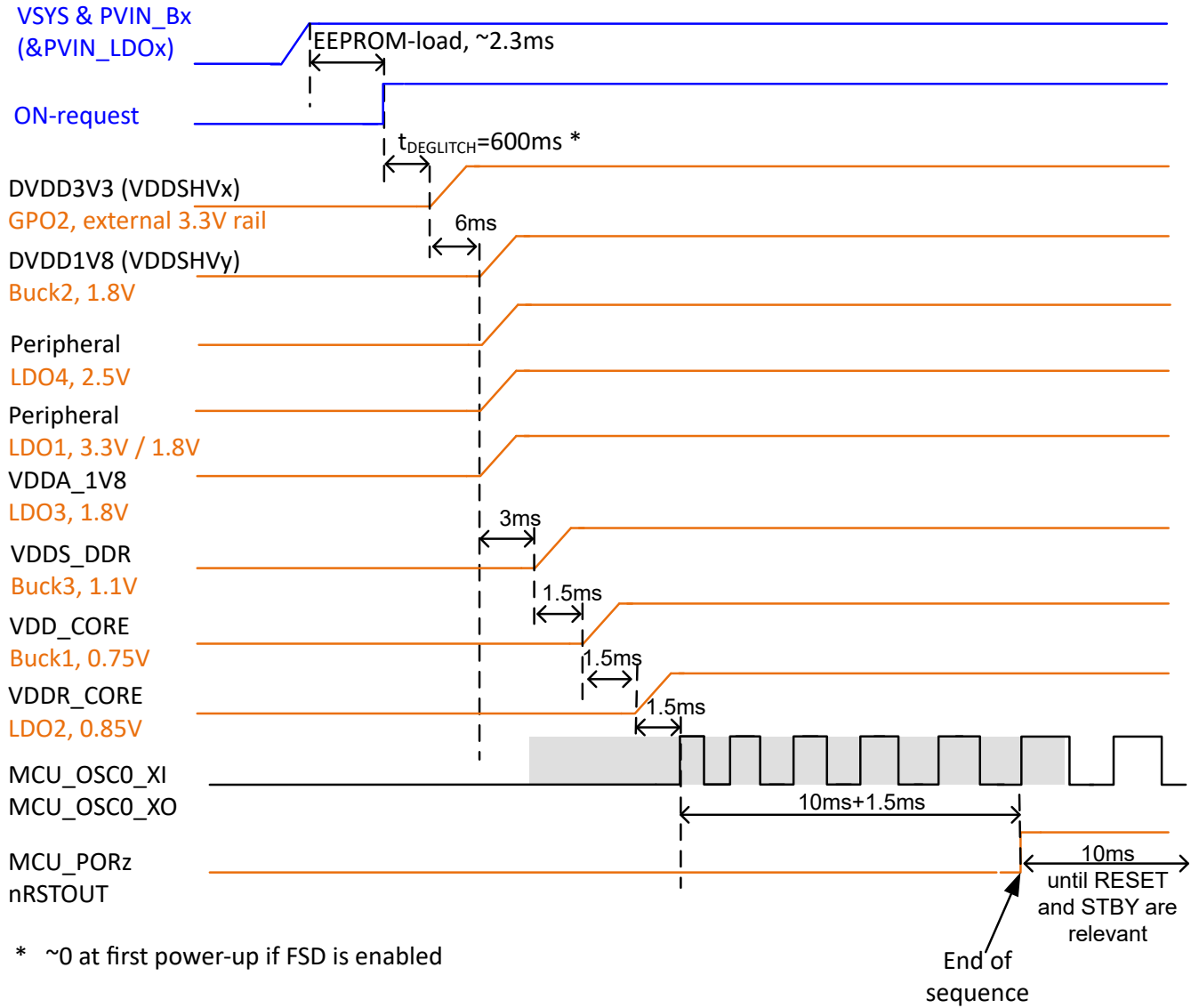
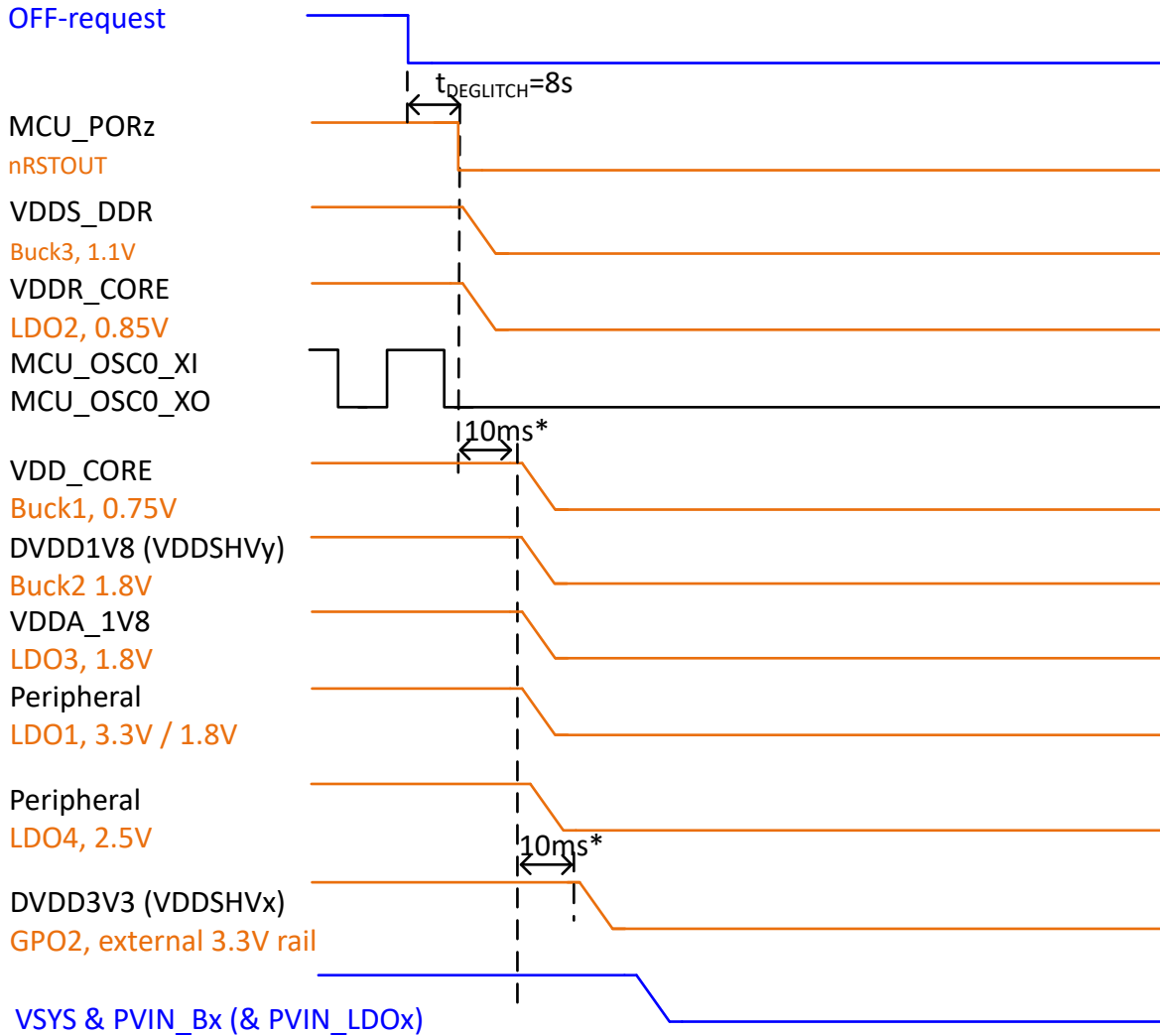


Figure 4-2. TPS6522053 Power-Up Sequence



* discharge-duration depends on Vout, Cout and load. Slot-duration needs to adopt.
 Slot-duration extends up to 8x its configured value.

Figure 4-3. TPS6522053 Power-Down Sequence

4.1 TPS6521901 Powering AM64x

Use case: VSYS=5V, DDR4 Memory

Figure 4-4 shows the TPS6521901 variant powering the AM64x processor on a system with 5 V input supply and DDR4 memory. The 5 V coming from the pre-regulator is connected to the main input supply for reference system (VSYS) and to the power input of the buck converters (PVIN_Bx). Buck1, Buck2 and Buck3 are used to supply VDD_CORE at 0.75 V, 3.3 V VDDSHVx IO and DDR IO respectively. Since Buck2 (3.3 V PMIC rail) is programmed to ramp up first in the power-up sequence, it can be used as the input supply for some of the LDOs to minimize power dissipation. LDO1, configured as bypass, allows dynamic SD card voltage changes between 3.3 V and 1.8 V. This voltage change on LDO1 can be triggered by I2C or by setting the VSEL_SD pin high (LDO1=3.3 V) or low (LDO1=1.8 V). LDO2, is used to supply the VDDR_CORE. LDO3 supports the 1.8 V analog domain and LDO4 supports the 2.5 V VPP for the DDR4 memory. This power solution requires an external discrete buck regulator to supply the 1.8 V VDDSHV IO domain. This external discrete can be enabled using the GPO1 of the PMIC. TPS6521901 comes pre-programmed to enable GPO1 in the second slot of the power-up sequence with a duration of 10 ms. The external discrete must ramp up and reach a stable output voltage within the 10 ms duration of the second slot (before the PMIC starts the 3rd slot of the power-up sequence). The remaining two general purpose pins (GPIO and GPO2) are free digital resources that are disabled by default but can be enabled through I2C after the PMIC completes the power-up sequence. Figure 4-5 and Figure 4-6 shows the power-up and power-down sequence programmed on TPS6521901.

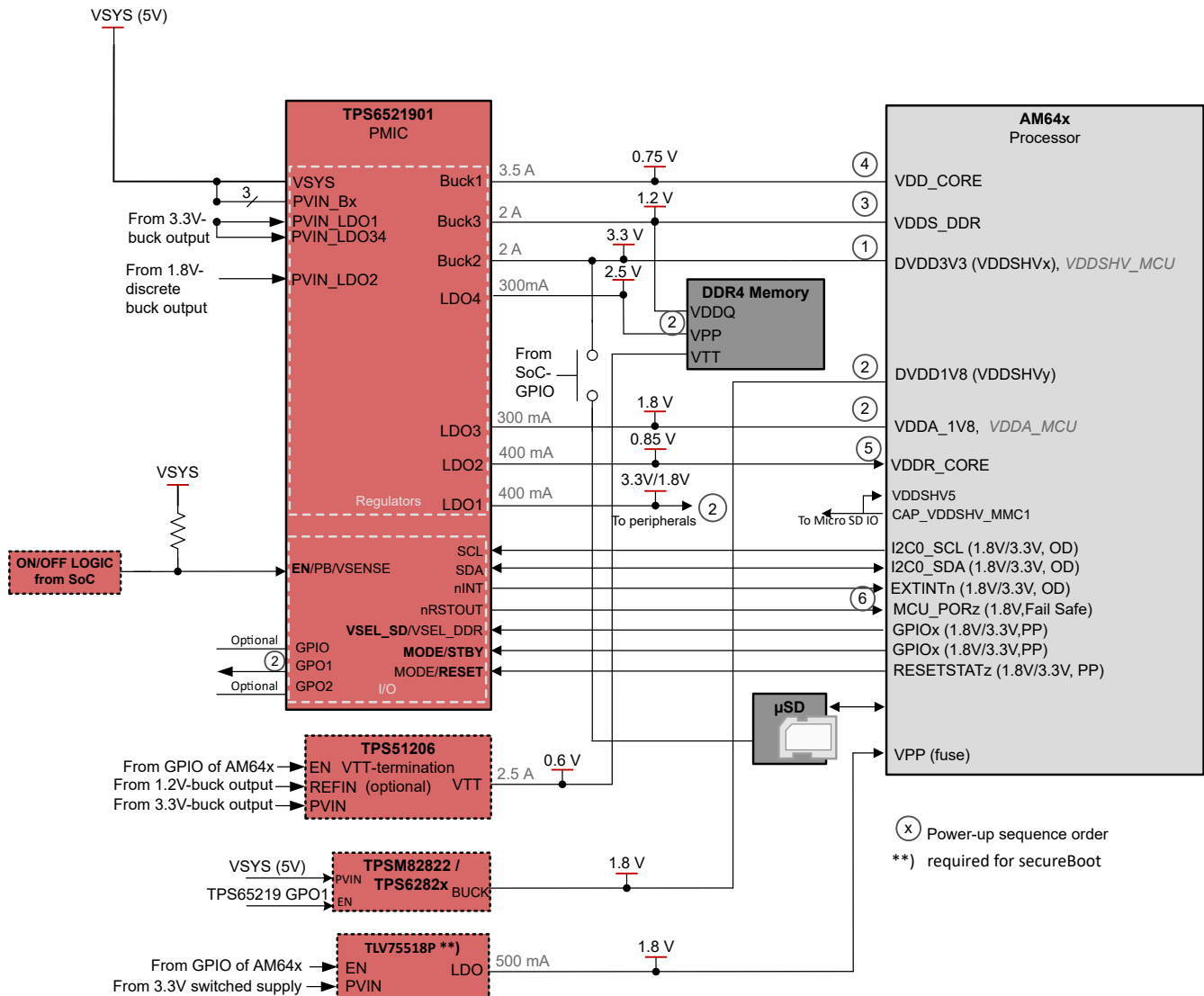


Figure 4-4. TPS6521901 Powering AM64x

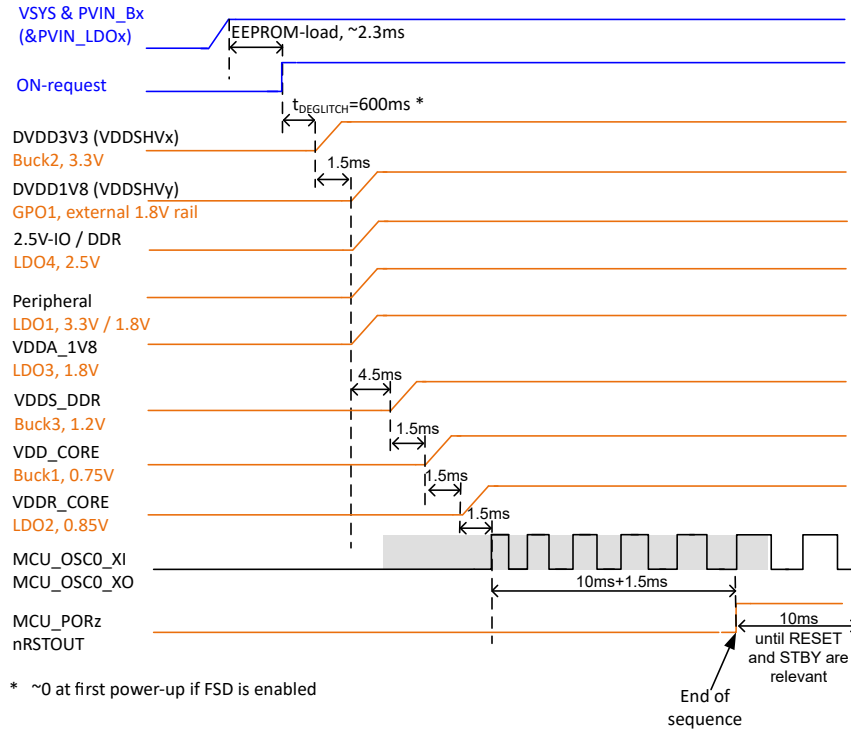


Figure 4-5. TPS6521901 Power-Up Sequence

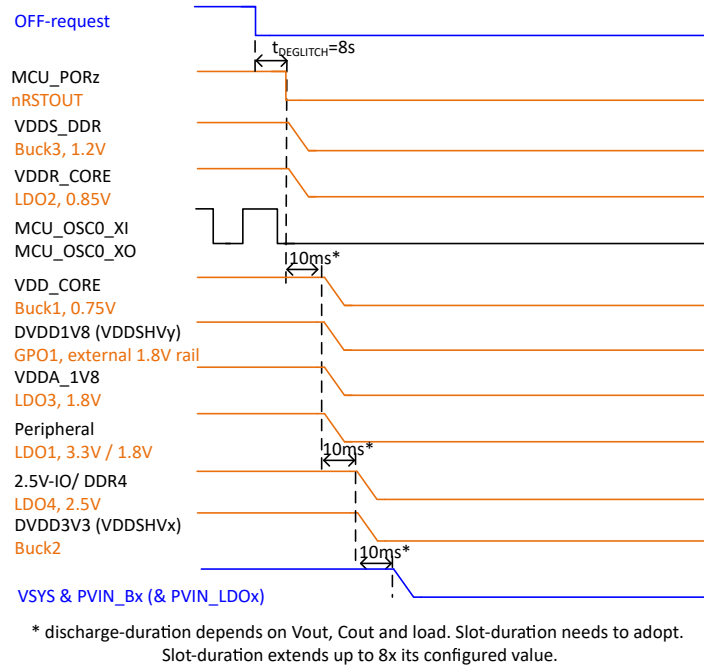


Figure 4-6. TPS6521901 Power-Down Sequence

4.2 TPS6521902 Powering AM64x

Use case: VSYS=3.3V, LDDR4 Memory

Figure 4-7 shows the TPS6521902 variant powering the AM64x processor on a system with 3.3 V input supply and LDDR4 memory. Buck1, LDO3, LDO2, and LDO1 are used to supply the same AM64x domains that were described in the previous block diagram. The 3.3 V coming from the pre-regulator can be combined with a power switch to supply the 3.3 V VDDSHVx IO domain. The GPO2 is pre-programmed to be enabled in the second slot of the power-up sequence with a duration of 10ms. It can be used to enable the external power switch and meet the processor sequence requirements. The switch must be selected with the right electrical spec to ramp and provide a stable output voltage within the 10 ms duration of the second slot (before the PMIC starts the next slot in the power-up sequence). Buck3 and Buck2 supports the 1.1 V and 1.8 V required by VDDSDR and the 1.8 V DVDD3V3 IO domain. They are also used to support the required voltages on the LPDDR4 memory. LDO4 is a free 2.5 V power resource that can be used for external peripherals like the Ethernet PHY. GPIO and GPO1 are free digital resources that are disable by default but could be enabled through I2C if needed. Figure 4-8 and shows the power-up and power-down sequence programmed on TPS6521902.

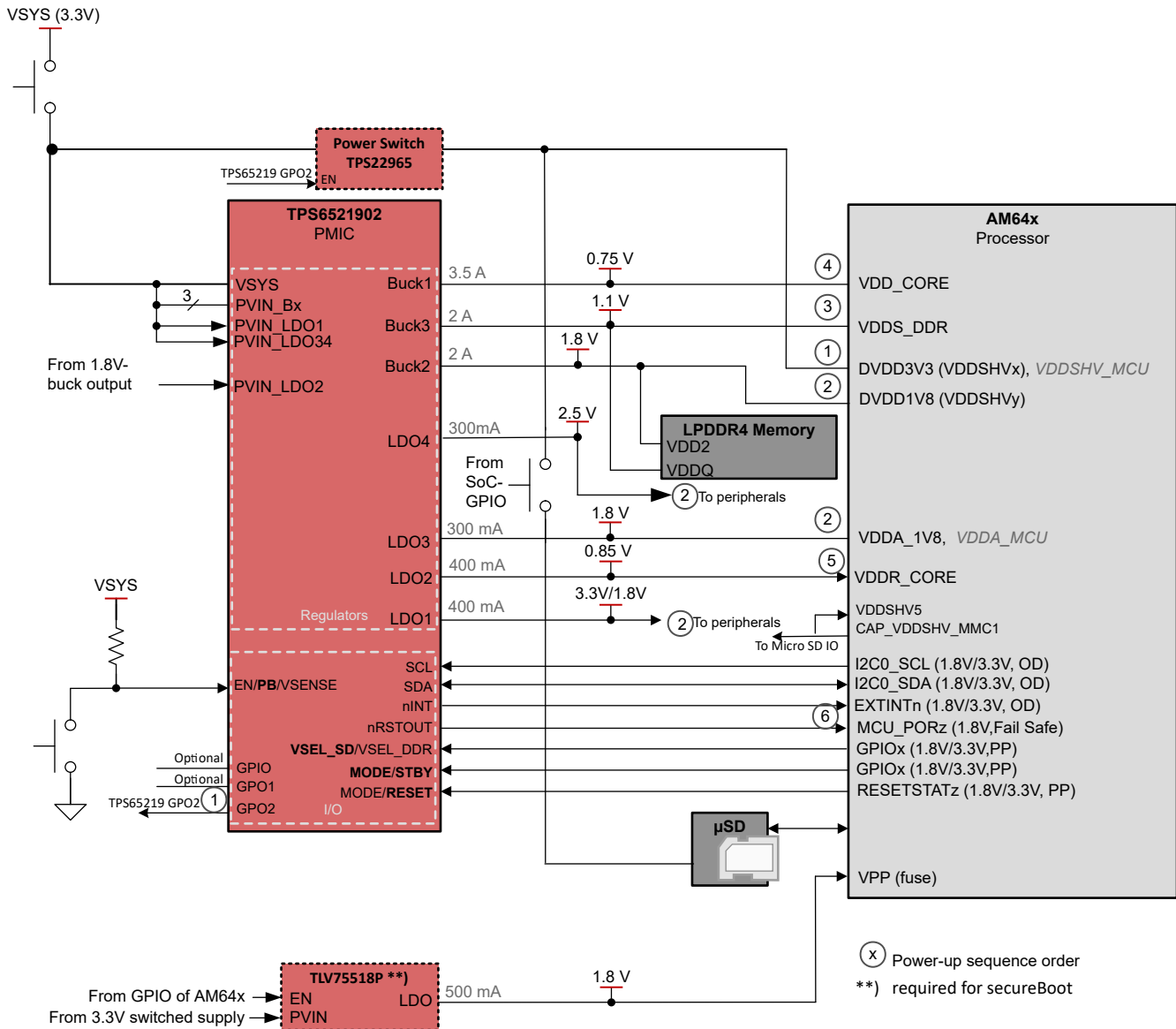


Figure 4-7. TPS6521902 Powering AM64x

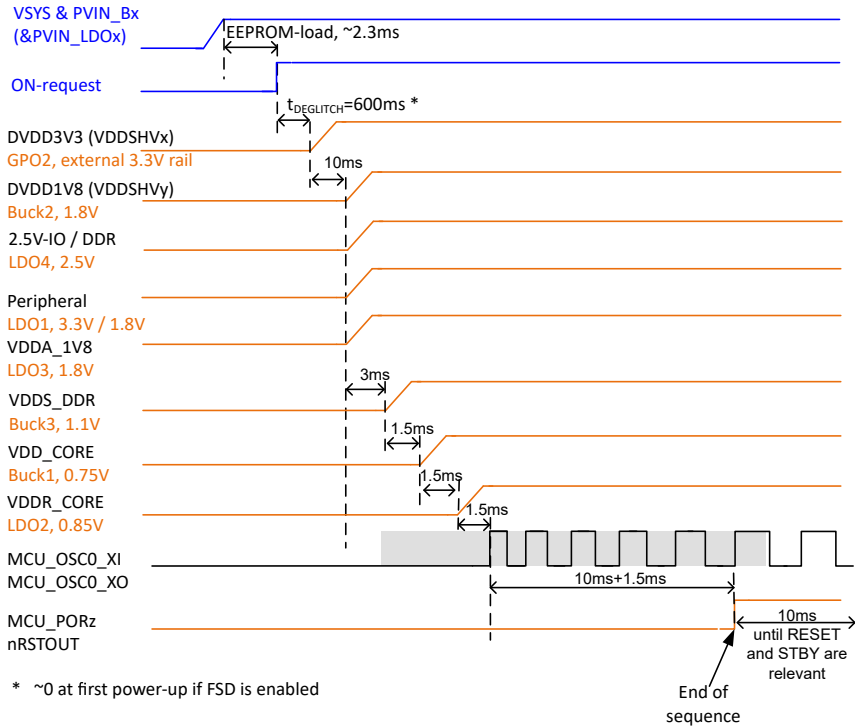


Figure 4-8. TPS6521902 Power-Up Sequence

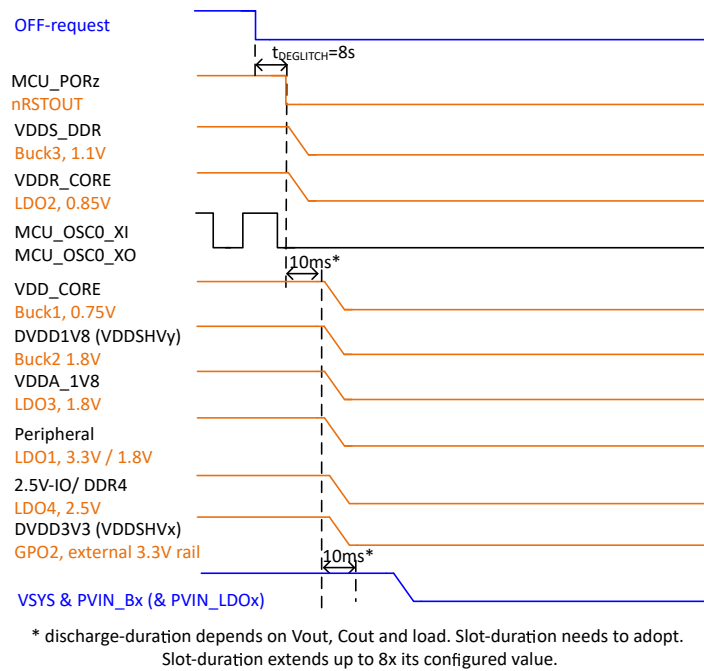


Figure 4-9. TPS6521902 Power-Down Sequence

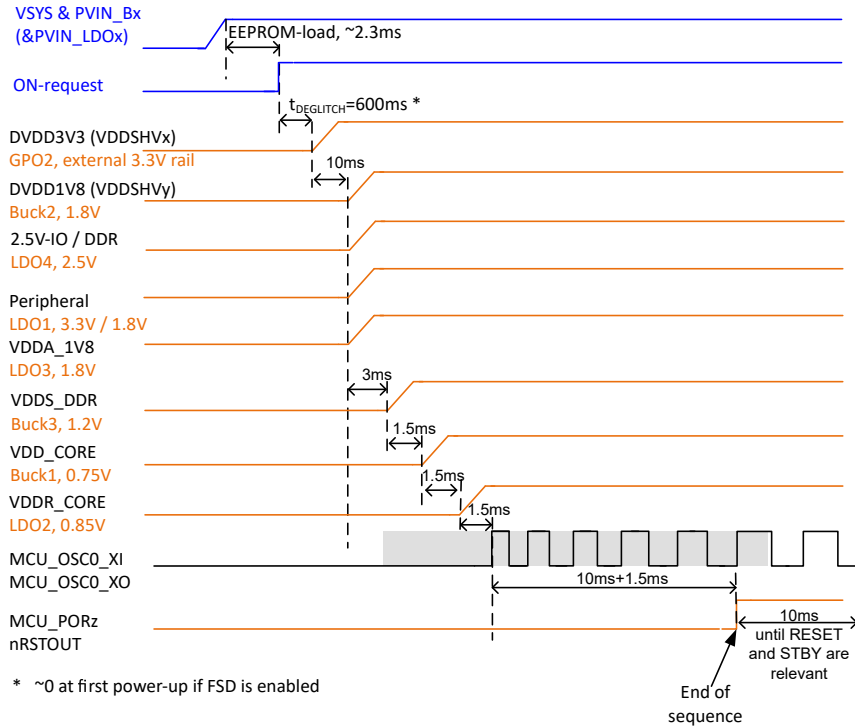


Figure 4-11. TPS6521903 Power-Up Sequence

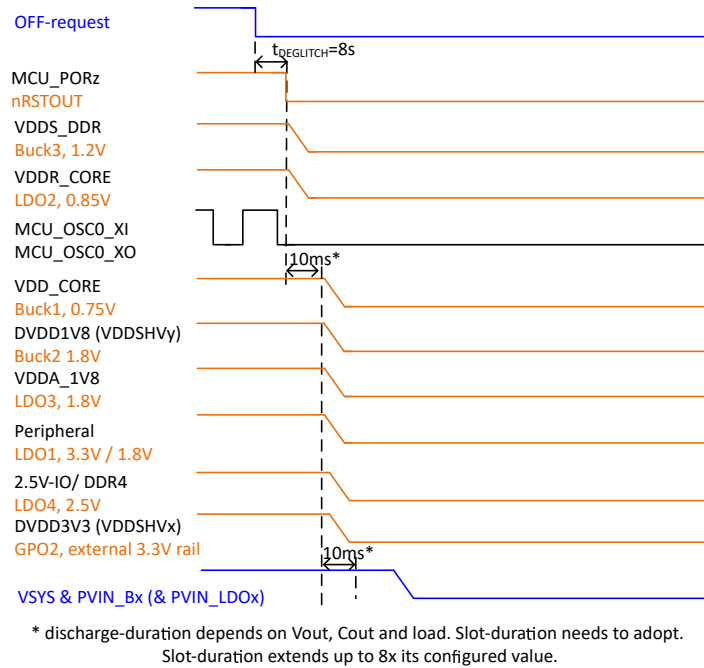


Figure 4-12. TPS6521903 Power-Down Sequence

4.4 TPS6521904 Powering AM64x

Use case: VSYS=3.3V, DDR4 Memory, VDD_CORE=0.85V

Figure 4-13 shows the TPS6521904 variant powering the AM64x processor on a system with 3.3 V input supply and DDR4. This configuration is similar to the TPS6521903 but in this scenario, VDD_CORE is operated at 0.85 V instead of 0.75 V. As stated on the AM64x data sheet, "VDD_CORE and VDDR_CORE are expected to be powered by the same source so they ramp together when VDD_CORE is operating at 0.85 V". This requirement on the processor allows to have both, VDD_CORE and VDDR_CORE supplied by the same PMIC rail (Buck1). LDO2 is a free power resource pre-programmed for 1.8V output which can be used to supply external peripherals. Similarly to the TPS6521903, this configuration also has GPO2 is pre-programmed to be enabled in the second slot of the power-up sequence with a duration of 10 ms. The configuration can be used to enable the external power switch and meet the processor sequence requirements. The switch must be selected with the right electrical spec to ramp and provide a stable output voltage within the 10 ms duration of the second slot (before the PMIC start the next slot in the power-up sequence). Figure 4-14 and Figure 4-15 shows the power-up and power-down sequence programmed on TPS6521904.

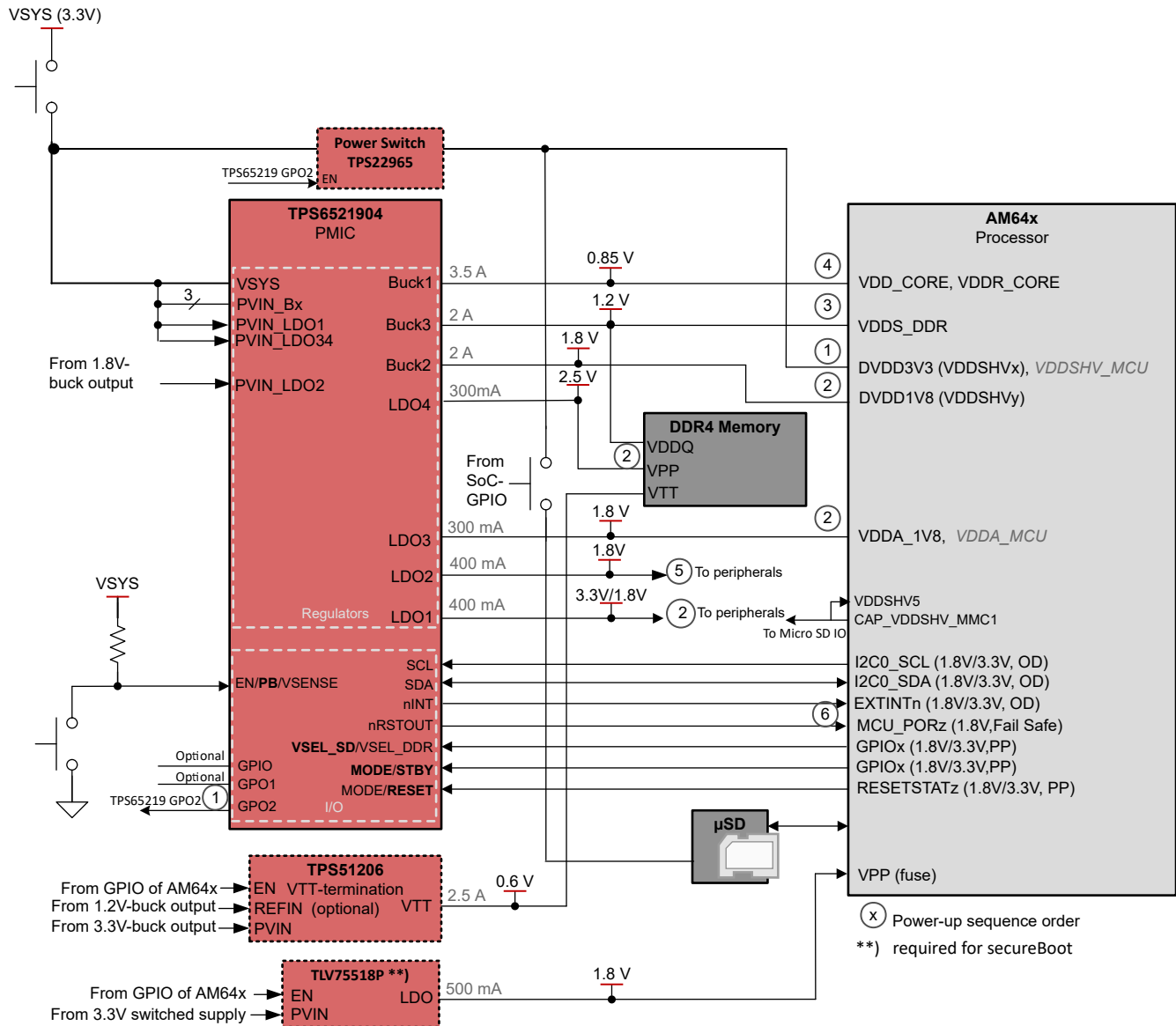


Figure 4-13. TPS6521904 Powering AM64x

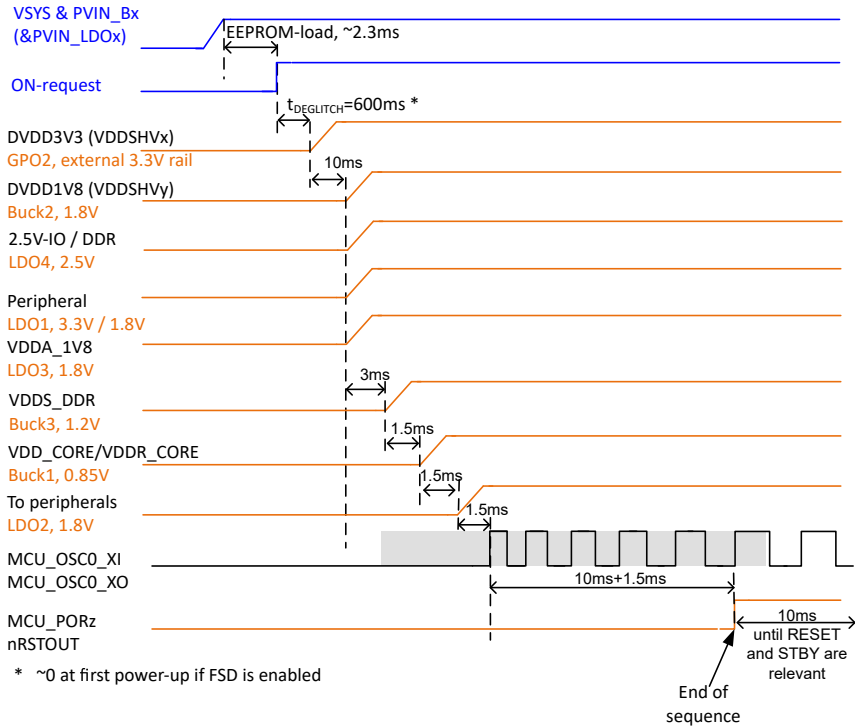


Figure 4-14. TPS6521904 Power-Up Sequence

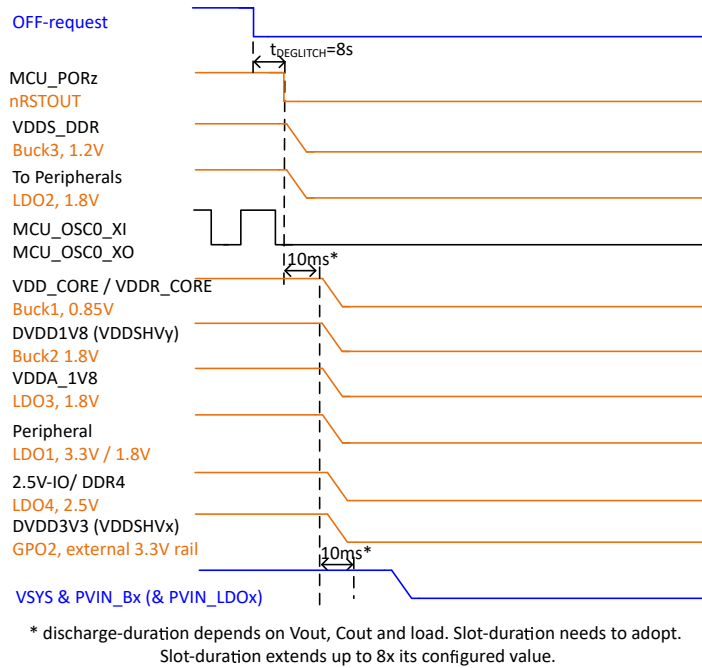


Figure 4-15. TPS6521904 Power-Down Sequence

5 References

1. Texas Instruments, [TPS65219 Integrated Power Management IC for ARM Cortex—A53 Processors and FPGAs](#) data sheet.
2. Texas Instruments, [AM64x Sitara™ Processors](#) data sheet.

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